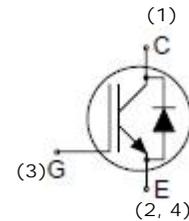


PRELIMINARY DATASHEET
**1200V 150A, SPT+ IGBT with soft, fast switching
 Anti-parallel Diode in Isolated SOT227 Package**
APPLICATIONS

- General inverters
- Uninterruptible power supplies (UPS)
- Welders

FEATURES

- Ultra low loss IGBT
- Highly rugged SPT design
- Pb-free finished; **RoHS Compliant**


MAXIMUM RATINGS

Parameter	Symbol	Value	Units
Collector-emitter voltage	V_{CE}	1200	V
DC collector current, $T_{jmax}=150^{\circ}C$ $T_C=80^{\circ}C$	I_C	150	A
Peak collector current	I_{CM}	300	
Diode forward current, $T_{jmax}=150^{\circ}C$ $T_C = 80^{\circ}C$	I_F	45	
Gate-emitter voltage	V_{GES}	± 20	V
IGBT short circuit SOA $V_{CC} = 900 V, V_{CEM} \leq 1200 V, V_{GE} \leq 15 V, T_j = 125^{\circ}C$	t_{PSC}	10	μs
Operating junction and storage temperature	T_j, T_{stg}	-40... +150	$^{\circ}C$

Thermal and Isolation Characteristics

Parameter	Symbol	Max. Value	Units
Characteristics			
IGBT thermal resistance, junction to case	R_{thJC}	0.14	K/W
Diode thermal resistance, junction to case	R_{thJCD}	0.76	
Isolation voltage, RMS (measured between terminals and mounting base, 50-60 Hz, for 1-3 seconds)	V_{ISO}	3000	V

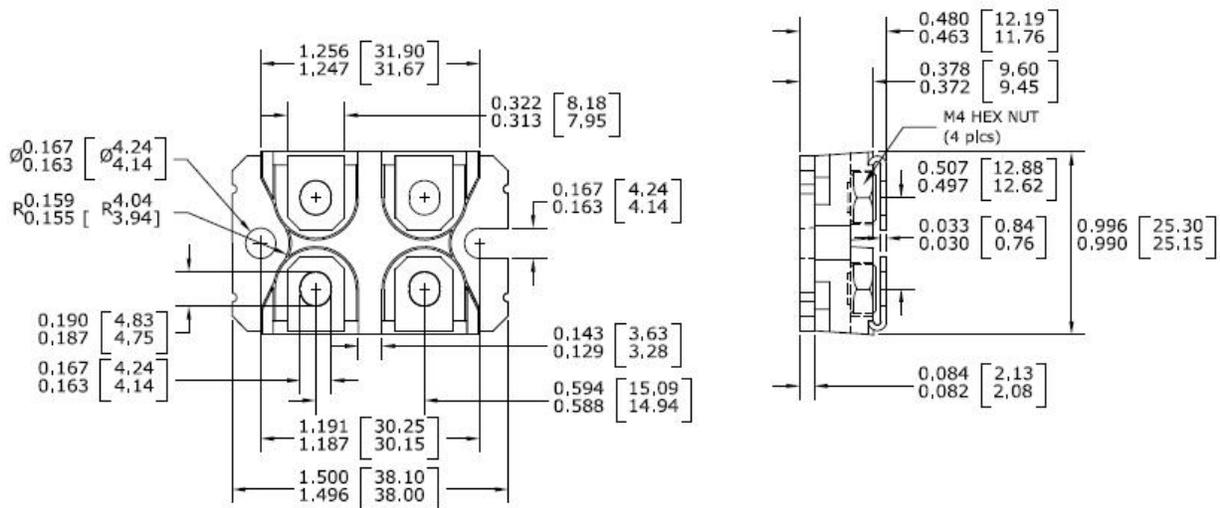
ELECTRICAL CHARACTERISTICS, at $T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
			Min.	Typ.	Max.	
Static Characteristics						
Collector-emitter breakdown voltage	$V_{(BR)CES}$	$V_{GE} = 0V, I_C = 1mA$	1200	-	-	V
Collector-emitter saturation voltage at $T_{vj}=25^\circ\text{C}$ at $T_{vj}=125^\circ\text{C}$	$V_{CE(sat)}$	$V_{GE} = 15V, I_C = 150A$	- -	1.9 2.1	- -	
Gate-emitter threshold voltage	$V_{GE(th)}$	$I_C = 6 mA, V_{CE} = V_{GE}$	5	6.2	7	
Diode forward voltage	V_F	$I_F = 45 A$	-	2.0	-	
Zero gate voltage collector current at $T_{vj} = 25^\circ\text{C}$ at $T_{vj} = 125^\circ\text{C}$	I_{CES}	$V_{CE} = 1200V, V_{GE} = 0$	- -	- 600	100 -	μA
Gate-emitter leakage current	I_{GES}	$V_{CE} = 0V, V_{GE} = 20V$ at $T_j = 125^\circ\text{C}$	-200	-	200	nA
Internal gate resistance	R_{Gint}		-	2	-	Ω
Dynamic Characteristics						
Input capacitance	C_{iss}	$V_{CE} = 25V,$ $V_{GE} = 0V,$ $f = 1MHz$	-	10.6	-	nF
Output capacitance	C_{oss}		-	0.71	-	
Reverse transfer capacitance	C_{rss}		-	0.47	-	

SWITCHING CHARACTERISTICS, at $T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
			Min.	Typ.	Max.	
IGBT Characteristics						
Turn-on delay time $T_j = 25^\circ\text{C}$ $T_j = 125^\circ\text{C}$	$t_{d(on)}$	$V_{CC}=600V, I_C = 150A,$ $V_{GE}=\pm 15V,$ $R_G=6.8\Omega, L_J=60nH$ Inductive Load	- -	190 220	- -	ns
Rise time $T = 25^\circ\text{C}$ $T_j = 125^\circ\text{C}$	t_r		- -	60 60	- -	
Turn-off delay time $T_j = 25^\circ\text{C}$ $T_j = 125^\circ\text{C}$	$t_{d(off)}$		- -	460 530	- -	
Fall time $T_j = 25^\circ\text{C}$ $T_j = 125^\circ\text{C}$	t_f		- -	55 75	- -	mJ
Turn-on energy $T_j = 25^\circ\text{C}$ $T_j = 125^\circ\text{C}$	E_{on}		- -	11.2 16.7	- -	
Turn-off energy $T_j = 25^\circ\text{C}$ $T_j = 125^\circ\text{C}$	E_{off}		- -	9.8 15.3	- -	
Short Circuit Current	I_{SC}		$V_{CC} = 900V, V_{GE} = 15V$ $t_{psc} \leq 10\mu s$ V_{CEM_1200V} at $T_C = 125^\circ\text{C}$	-	650	-
Gate Charge	Q_g	$V_{CE} = 600V, I_C = 150A$ $V_{GE} = -15V \dots 15V$	-	1530	-	nC
Anti-parallel Diode Characteristics						
Diode reverse recovery charge	Q_{rr}	$I_F = 45A$ $dI_F/dt = -550A/\mu s$ $V_R = 600V$ $V_{GE} = -15V$	-	3.60	-	μC
Diode peak reverse recovery current	I_{rrm}		-	39	-	A

Package Outline Drawing



CAUTION: These devices are ESD sensitive. Use proper handling procedure.

Disclaimer

These specifications may not be considered as a guarantee of components characteristics. Components have to be tested depending on intended application as adjustments may be necessary. The use of **iQXPRZ Power Inc.** components in life support appliances and systems are subject to written approval of **iQXPRZ Power Inc.**